

under 37 C.F.R. § 1.136(a), and any fees required therefor (including fees for net addition of claims) are hereby authorized to be charged to our Deposit Account No. 19-0036.

Amendments

In the Specification:

Please substitute the paragraph beginning on page 4, line 8, with the following paragraph:

B' The present invention provides, in another embodiment, a method of achieving a degree of planarity among contact portions of a plurality of contact structures mounted to a substrate, in which the method includes creating the substrate with the plurality of contact structures connected to a first surface of the substrate, the contact portions of the contact structures having a first planar relationship relative to one another, and applying a plurality of forces selectively to the substrate to deform the substrate and achieve a second planar relationship of the contact portions of the contact structures relative to one another.

Please substitute the paragraph beginning on page 8, line 15, with the following paragraph:

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More detailed discussions of printed wiring boards (e.g., probe cards), interposers, space transformers, drive plates, resilient contact structures, contact elements and other components of a probe card assembly that can be used in conjunction with the present invention can be found in U.S. Patent No. 5,974,662, U.S. Patent Application No. 08/920,255, titled "Making Discrete Power Connections to a Space Transformer of a Probe Card Assembly," now U.S. Patent No. 6,050,829, and U.S. Patent Application No. 09/042,606, titled "Probe Card Assembly and Kit," now U.S. Patent No. _____, all of which are incorporated by reference herein.

In the Claims:

Please cancel claims ~~11~~ to ~~20~~ without prejudice or disclaimer.

Please substitute the following claims 21 to 27 for the pending claims 21 to 27:

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21. (Amended) A method of adjusting surfaces of a plurality of substrates, the surfaces defined by contact portions of a plurality of contact elements coupled to the plurality of substrates, the method comprising:

applying a force to at least one substrate in the plurality of substrates to deform the at least one substrate; and

adjusting at least one substrate in the plurality of substrates such that the surfaces of the plurality of substrates define a collective surface shape.